POM-C REGENERATED

POLYACETAL COPOLYMER REGENERATED

Material description

The environmentally friendly alternative to original material - massively reduces your CO2 footprint! Offcuts from production are reprocessed into new material, but retain their top properties. POM-C is a highly crystalline thermoplastic with very good sliding properties and high abrasion resistance. This construction material has an ideal combination of strength, stiffness and toughness. Its excellent impact strength even at temperatures down to -40°C, chemical resistance, high dimensional stability and low-moisture absorption are paired with excellent machinability.

Conformities

RoHS, REACH

Physical properties	Test method	Value	Unit
Density	DIN EN ISO 1183-1	1.41	g/cm3
Water absorbtion	DIN EN ISO 62	0.24	%
Sliding friction			
Abrasion resistance		•	

Mechanical properties	Test method	Value	Unit
Yield stress	DIN EN ISO 527	66	MPa
Elongation at break	DIN EN ISO 527	40	%
Tensile modulus of elasticity	DIN EN ISO 527	3000	MPa
Notched impact strength	DIN EN ISO 527	8	kJ/m2
Shore Hardness D	ISO 868	79	

Thermal properties	Test method	Value	Unit
Thermal conductivity	DIN 52612-2	0.31	W/(m*K)
Heat capacity	DIN 52612-1	1.5	kJ/(kg*K)
Coefficient of thermal expansion	DIN 53752	110	10 ^{-6*K} -1
Operating temperature short term		140	°C
Operating temperature long term		-50 bis 100	°C
Heat deflection temperature	DIN EN ISO 75 / A	100	°C
Flammability	UL 94, 3 mm	НВ	

Electrical properties	Test method	Value	Unit
Volume resistivity	IEC 60093	10 ¹³	Ω * cm
Surface resistivity	IEC 60093	10 ¹²	Ω * cm
Dielectric strength	IEC 60243	20	kV/mm

These technical data have been determined as average values by our suppliers from many individual measurements. In all measurements, the test specimens were tested in the dry state. We pass on the data with reservation. The table does not claim to be complete or correct. Material technology is subject to constant further development. No rights or guarantees can be derived from it. Own tests are necessary because the environmental and operating conditions (humidity, temperature, mechanical forces, radiation and chemicals, etc.) set limits in the application.

